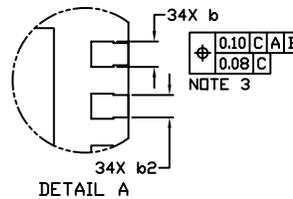
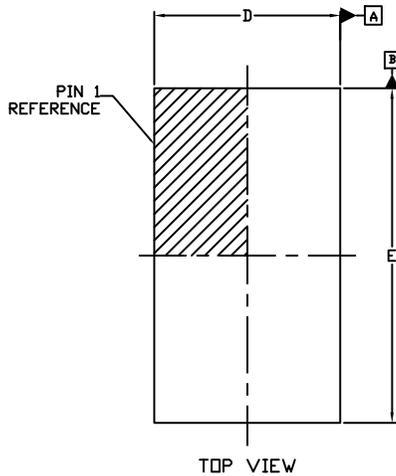
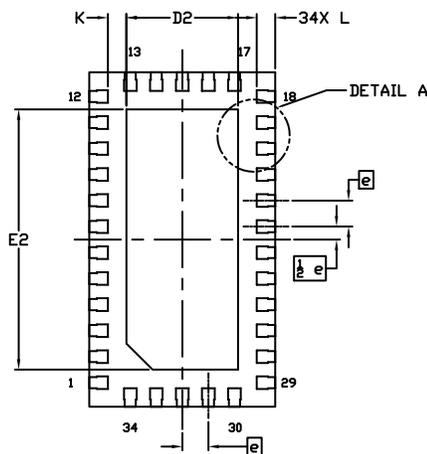
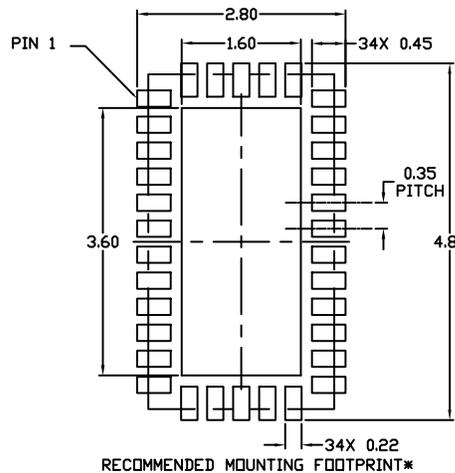
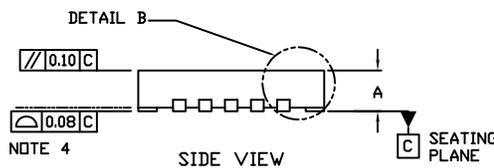
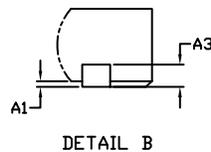


UQFN34 2.5x4.5, 0.35P  
CASE 523BR  
ISSUE A

DATE 10 DEC 2020



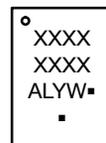
DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.50	0.55	0.60
A1	0.00	---	0.05
A3	0.15 REF		
b	0.12	0.17	0.22
b2	0.10	0.15	0.20
D	2.40	2.50	2.60
D2	1.40	1.50	1.60
E	4.40	4.50	4.60
E2	3.40	3.50	3.60
e	0.35 BSC		
K	0.25 REF		
L	0.15	0.25	0.35



BOTTOM VIEW

GENERIC MARKING DIAGRAM\*

- A = Assembly Location
- L = Wafer Lot
- Y = Year
- W = Work Week
- = Pb-Free Package



\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

(Note: Microdot may be in either location)

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